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### **Power MOSFET**

### 25 V, 65 A, Single N-Channel, DPAK

### **Features**

- Low R<sub>DS(on)</sub>
- Ultra Low Gate Charge
- Low Reverse Recovery Charge
- Pb-Free Packages are Available

### **Applications**

- Desktop CPU Power
- DC-DC Converters
- High and Low Side Switch

### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Param   | Symbol           | Value                 | Unit                              |               |      |
|---|------------------|-----------------------|-----------------------------------|---------------|------|
| Drain-to-Source Volta   | V <sub>DSS</sub> | 25                    | V                                 |               |      |
| Gate-to-Source Voltage  |                  |                       | V <sub>GS</sub>                   | ±20           | V.   |
| Continuous Drain  | - C              | T <sub>C</sub> = 25°C | I <sub>D</sub>                    | 65            | Α    |
| Current (R <sub>0JC</sub> ) Limited by Die  | 10 x .           | T <sub>C</sub> = 85°C | l.T                               | 45            | 70n. |
| Continuous Drain<br>Current (R <sub>0</sub> JC) Limited<br>by Wire  | Steady<br>State  | T <sub>C</sub> = 25°C | ID                                | 32            | A    |
| Power Dissipation $(R_{\theta JC})$   | N.100            | T <sub>C</sub> = 25°C | P <sub>D</sub>                    | 50            | W    |
| Continuous Drain  | W.100            | T <sub>A</sub> = 25°C | I <sub>D</sub>                    | 11.4          | Α    |
| Current (Note 1)  | Steady           | $T_A = 85^{\circ}C$   | T.TW                              | 8.9           | - 11 |
| Power Dissipation (Note 1)  | State            | T <sub>A</sub> = 25°C | P <sub>D</sub>                    | 1.88          | W    |
| Continuous Drain  | - 747            | $T_A = 25^{\circ}C$   | $I_{D}$                           | 9.5           | Α    |
| Current (Note 2)  | Steady           | T <sub>A</sub> = 85°C | TI                                | 7.4           | W    |
| Power Dissipation (Note 2)  | State            | T <sub>A</sub> = 25°C | $P_{D}$                           | 1.3           | W    |
| Pulsed Drain Current  | t <sub>p</sub> = | : 10 μs               | I <sub>DM</sub>                   | 130           | Α    |
| Operating Junction and Storage<br>Temperature   |                  |                       | T <sub>J</sub> , T <sub>stg</sub> | -55 to<br>175 | °C   |
| Drain-to-Source (dv/dt  | dv/dt            | 2.0                   | V/ns                              |               |      |
| Source Current (Body D  | Is               | 2.1                   | Α                                 |               |      |
| Single Pulse Drain-to-Source Avalanche Energy ( $V_{DD}$ = 24 V, $V_{GS}$ = 10 V, $I_{L}$ = 12 A, L = 1.0 mH, $R_{G}$ = 25 $\Omega$ ) |                  |                       | E <sub>AS</sub>                   | 71.7          | mJ   |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s)   |                  |                       | V. T <sub>L</sub>                 | 260           | °C   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
- 2. Surface-mounted on FR4 board using the minimum recommended pad size (Cu area = 0.15 in sq) [1 oz] including traces.

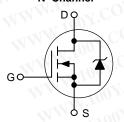


### ON Semiconductor®

### http://onsemi.com

| V <sub>(BR)DSS</sub> | R <sub>DS(on)</sub> TYP | I <sub>D</sub> MAX |
|----------------------|-------------------------|--------------------|
| 25 V                 | 6.5 mΩ @ 10 V           | 65 A               |
| 25 V                 | 9.7 mΩ @ 4.5 V          | 00 A               |

### N-Channel





**DPAK** 

(Bend Lead)

STYLE 2

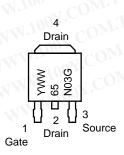


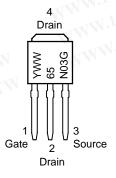
CASE 369D **DPAK** (Straight Lead) STYLE 2



CASE 369AC 3 IPAK (Straight Lead)

### MARKING DIAGRAMS & PIN ASSIGNMENTS





= Year WW = Work Week 65N03 = Device Code = Pb-Free Package

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

### THERMAL RESISTANCE MAXIMUM RATINGS

|                     | WWW.100X.COM.TYNTE              | 65N03R           |       |      |
|---------------------|---------------------------------|------------------|-------|------|
| THERMAL RESIST      | ANCE MAXIMUM RATINGS  Parameter | Symbol           | Value | Unit |
| Junction-to-Case (D | Prain)                          | R <sub>θJC</sub> | 2.5   | °C/V |
| Junction-to-Ambien  | t – Steady State (Note 3)       | $R_{	heta JA}$   | 80    |      |
| Junction-to-Ambien  | t – Steady State (Note 4)       | $R_{\theta JA}$  | 115   |      |

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted)

| Parameter  | Symbol                               | Test Condition  |                          | Min      | Тур    | Max    | Unit  |
|--|--------------------------------------|---|--------------------------|----------|--------|--------|-------|
| OFF CHARACTERISTICS  | 1007                                 | MITW  |                          | 10       | OXIC   | W.T.W  |       |
| Drain-to-Source Breakdown Voltage                            | V <sub>(BR)DSS</sub>                 | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                           |                          | 25       | 29.5   | WT     | V     |
| Drain-to-Source Breakdown Voltage<br>Temperature Coefficient | V <sub>(BR)DSS</sub> /T <sub>J</sub> | LCON.   |                          | MMA      | 19.2   | OWIN   | mV/°C |
| Zero Gate Voltage Drain Current                              | I <sub>DSS</sub>                     | $V_{GS} = 0 V$  | $T_J = 25^{\circ}C$      | MAL      | 100Y.  | 1.5    | μΑ    |
|  | TWW.IO                               |   | T <sub>J</sub> = 125°C   | WW       | Voc    | 10     | W     |
| Gate-to-Source Leakage Current                               | I <sub>GSS</sub>                     | $V_{DS} = 0 V, V$   | <sub>GS</sub> = ±20 V    | TXN      | W.In.  | ±100   | nA    |
| ON CHARACTERISTICS (Note 5)                                  | All As                               | 1007.   | V.I.M                    | All a    | TN 100 | Mos    | J. A. |
| Gate Threshold Voltage                                       | V <sub>GS(TH)</sub>                  | $V_{GS} = V_{DS}$   | I <sub>D</sub> = 250 μA  | 1.0      | 1.74   | 2.0    | V     |
| Negative Threshold Temperature Coefficient                   | V <sub>GS(TH)</sub> /T <sub>J</sub>  | CC CC   | )Nr.                     | W        | 4.8    | M.CO   | mV/°C |
| Drain-to-Source On Resistance                                | R <sub>DS(on)</sub>                  | V <sub>GS</sub> = 10 V  | ', I <sub>D</sub> = 30 A |          | 6.5    | 8.4    | mΩ    |
|  | 11 11                                | V <sub>GS</sub> = 4.5 \   | /, I <sub>D</sub> = 30 A |          | 9.7    | 14.6   | M.T   |
| Forward Transconductance                                     | 9FS                                  | V <sub>DS</sub> = 15 V  | , I <sub>D</sub> = 15 A  |          | 27     | 1007.0 | mHos  |
| CHARGES, CAPACITANCES AND GATE RE                            | SISTANCE                             | WW.   | COM                      | V        | MAN    | · And  | COR   |
| Input Capacitance  | C <sub>iss</sub>                     | V <sub>GS</sub> = 0 V, f = 1.0 MHz,<br>V <sub>DS</sub> = 20 V           |                          | - 1      | 1177   | 1400   | pF    |
| Output Capacitance   | C <sub>oss</sub>                     |   |                          | 14       | 555    | W.1003 | V.CO  |
| Reverse Transfer Capacitance                                 | C <sub>rss</sub>                     |   |                          | TW       | 218    | 100    |       |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                  | $V_{GS} = 5.0 \text{ V}, V_{DS} = 10 \text{ V},$ $I_{D} = 30 \text{ A}$ |                          | TW       | 12.2   | 16     | nC    |
| Threshold Gate Charge  | Q <sub>G(TH)</sub>                   |   |                          |          | 1.5    | MANTA  |       |
| Gate-to-Source Charge  | Q <sub>GS</sub>                      |   |                          | V.L.     | 2.95   | 1      |       |
| Gate-to-Drain Charge   | $Q_{GD}$                             |   |                          | WILL     | 6.08   | MAN    |       |
| SWITCHING CHARACTERISTICS (Note 6)                           | NI.                                  | WW  | V. CC                    | ) In a   |        | MALA   | .005  |
| Turn-On Delay Time   | t <sub>d(on)</sub>                   | 7.7   | M.100                    | OM.      | 6.3    |        | ns    |
| Rise Time  | t <sub>r</sub>                       | V <sub>GS</sub> = 10 V,   | $V_{DS} = 25 \text{ V},$ | T.MOD    | 18.6   | N T    |       |
| Turn-Off Delay Time  | t <sub>d(off)</sub>                  | $I_D = 30 \text{ A}, I$   |                          | 00-11    | 20.3   | MA     |       |
| Fall Time  | t <sub>f</sub>                       | I XX  | MM.TO                    | COM      | 8.8    | W      |       |
| DRAIN-SOURCE DIODE CHARACTERISTIC                            | S ON                                 | -1  | TANN Too                 | -1 COM   |        | - 1    | WW.   |
| Forward Diode Voltage  | V <sub>SD</sub>                      | $V_{GS} = 0 V$  | $T_J = 25^{\circ}C$      |          | 0.85   | 1.1    | V     |
|  | N.Con                                | $I_{S} = 20 \text{ A}$  | T <sub>J</sub> = 125°C   | 10 X .C. | 0.72   |        | 1111  |
| Reverse Recovery Time  | t <sub>RR</sub>                      |   | WWW.                     | any.Ct   | 28.8   |        | ns    |
| Charge Time  | ta                                   | $V_{GS} = 0 \text{ V, dl}_{S}$  | /dt = 100 A/μs,          | *1 C     | 12.8   | KÍ     |       |
| Discharge Time   | t <sub>b</sub>                       | I <sub>S</sub> = 20 A   |                          | 700 7.   | 16     | 1      |       |
| Reverse Recovery Time  | Q <sub>RR</sub>                      |   |                          | 100%     | 20     |        | nC    |
| PACKAGE PARASITIC VALUES                                     | V. To                                | JAI.  | WW                       | N. P.    |        | •      |       |
| Source Inductance  | L <sub>S</sub>                       | T <sub>A</sub> = 25°C   |                          |          | 2.49   |        |       |
| Drain Inductance   | L <sub>D</sub>                       |   |                          |          | 0.02   |        | nΗ    |
| Gate Inductance  | L <sub>G</sub>                       |   |                          |          | 3.46   |        |       |
| Gate Resistance  | $R_{G}$                              |   |                          |          | 1.75   |        | Ω     |

- 3. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
- 4. Surface-mounted on FR4 board using the minimum recommended pad size (Cu area = 0.15 in sq [1 oz] including traces).
- 5. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.
- 6. Switching characteristics are independent of operating junction temperatures.

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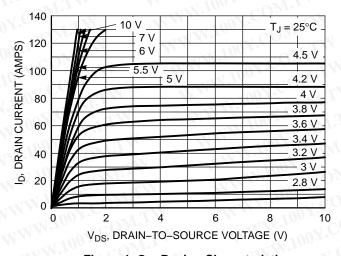


Figure 1. On-Region Characteristics

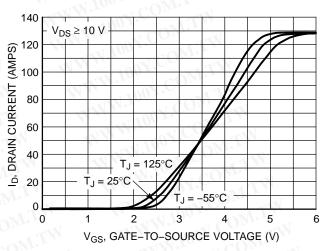


Figure 2. Transfer Characteristics

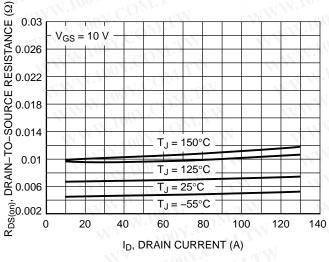


Figure 3. On-Resistance versus Drain Current and Temperature

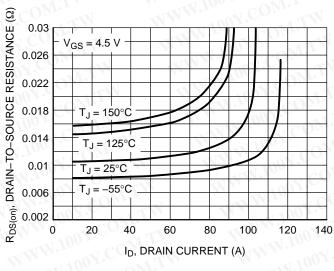


Figure 4. On-Resistance versus Drain Current and Temperature

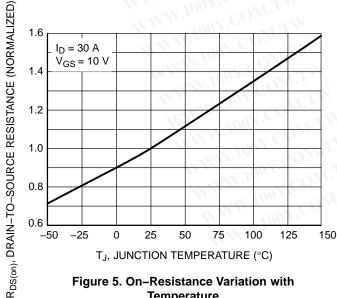


Figure 5. On-Resistance Variation with **Temperature** 

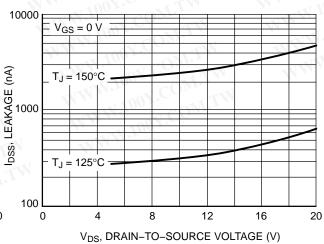


Figure 6. Drain-To-Source Leakage **Current versus Voltage** 

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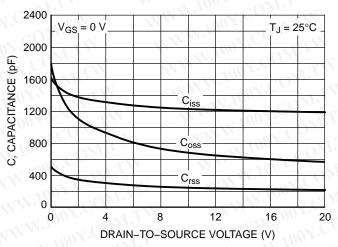


Figure 7. Capacitance Variation

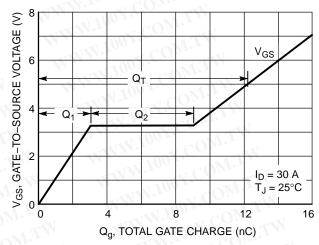


Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

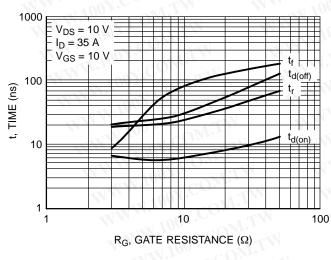


Figure 9. Resistive Switching Time Variation versus Gate Resistance

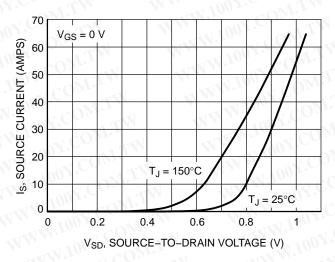


Figure 10. Diode Forward Voltage versus Current

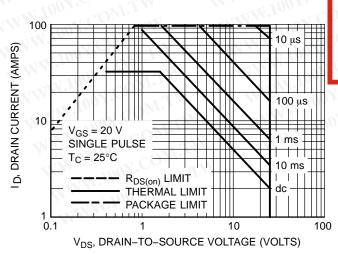


Figure 11. Maximum Rated Forward Biased Safe Operating Area

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## WWW.100Y.COM.TW NTD65N03R

# VWW.100Y.COM.TW

| Outlin Noveles and | 7 ( O n. 15 l  | OL tool to+           |
|--------------------|--|-----------------------|
| Order Number       | Package  | Shipping <sup>†</sup> |
| NTD65N03R          | DPAK-3   | 75 Units / Rail       |
| NTD65N03RG         | DPAK-3<br>(Pb-Free)  | 75 Units / Rail       |
| NTD65N03RT4        | DPAK-3   | 2500 / Tape & Ree     |
| NTD65N03RT4G       | DPAK-3<br>(Pb-Free)  | 2500 / Tape & Ree     |
| NTD65N03R-1        | DPAK-3 Straight Lead                                       | 75 Units / Rail       |
| NTD65N03R-1G       | DPAK-3 Straight Lead<br>(Pb-Free)                          | 75 Units / Rail       |
| NTD65N03R-35       | DPAK Straight Lead Trimmed (3.5 ± 0.15 mm)                 | 75 Units / Rail       |
| NTD65N03R-35G      | DPAK Straight Lead Trimmed<br>(3.5 ± 0.15 mm)<br>(Pb-Free) | 75 Units / Rail       |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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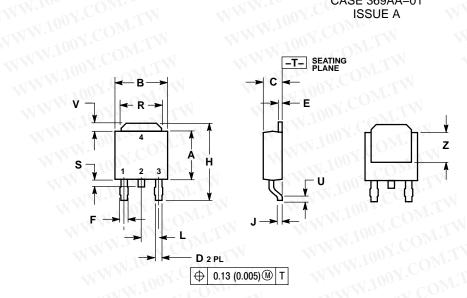
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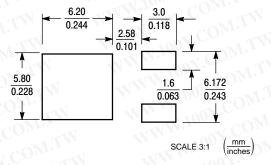
## WWW.100Y.COM. **PACKAGE DIMENSIONS**

**DPAK (SINGLE GUAGE)** CASE 369AA-01

**ISSUE A** 



### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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### NOTES

- 1. DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

| "Tr | INC   | HES   | MILLIMETER |       |  |
|-----|-------|-------|------------|-------|--|
| DIM | MIN   | MAX   | MIN        | MAX   |  |
| Α   | 0.235 | 0.245 | 5.97       | 6.22  |  |
| В   | 0.250 | 0.265 | 6.35       | 6.73  |  |
| С   | 0.086 | 0.094 | 2.19       | 2.38  |  |
| D   | 0.025 | 0.035 | 0.63       | 0.89  |  |
| Е   | 0.018 | 0.024 | 0.46       | 0.61  |  |
| FC  | 0.030 | 0.045 | 0.77       | 1.14  |  |
| Н   | 0.386 | 0.410 | 9.80       | 10.40 |  |
| J   | 0.018 | 0.023 | 0.46       | 0.58  |  |
| E.  | 0.090 | BSC   | 2.29 BSC   |       |  |
| R   | 0.180 | 0.215 | 4.57       | 5.45  |  |
| S   | 0.024 | 0.040 | 0.60       | 1.01  |  |
| U   | 0.020 |       | 0.51       |       |  |
| ٧   | 0.035 | 0.050 | 0.89       | 1.27  |  |
| 7   | 0 155 | 0.7   | 3 93       | CIE.  |  |

STYLE 2: PIN 1. GATE

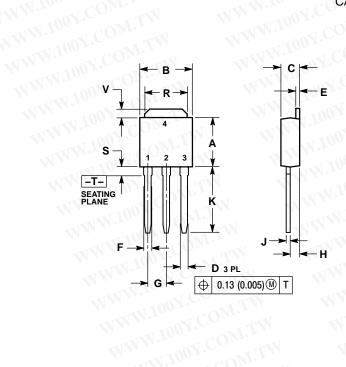
- - 2. DRAIN 3. SOURCE 4. DRAIN

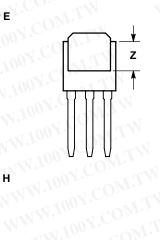
## WWW.100Y.COM.TW WWW.100Y.COM.T **PACKAGE DIMENSIONS**

WWW.100Y.COM **DPAK** CASE 369D-01 **ISSUE B** 

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- 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

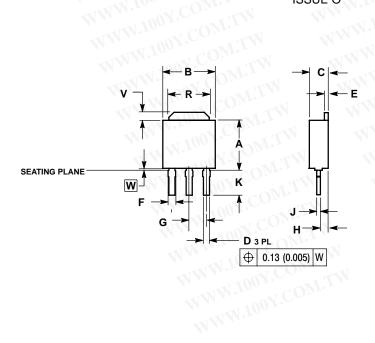
| 44  | INC   | HES       | MILLIMETERS |        |  |
|-----|-------|-----------|-------------|--------|--|
| DIM | MIN   | MAX       | MIN         | MAX    |  |
| Α   | 0.235 | 0.245     | 5.97        | 6.35   |  |
| В   | 0.250 | 0.265     | 6.35        | 6.73   |  |
| C   | 0.086 | 0.094     | 2.19        | 2.38   |  |
| D   | 0.027 | 0.035     | 0.69        | 0.88   |  |
| Е   | 0.018 | 0.023     | 0.46        | 0.58   |  |
| F   | 0.037 | 0.045     | 0.94        | 1.14   |  |
| G   | 0.090 | 0.090 BSC |             | BSC    |  |
| Н   | 0.034 | 0.040     | 0.87        | 1.01   |  |
| J   | 0.018 | 0.023     | 0.46        | 0.58   |  |
| K   | 0.350 | 0.380     | 8.89        | 9.65   |  |
| R   | 0.180 | 0.215     | 4.45        | 5.45   |  |
| S   | 0.025 | 0.040     | 0.63        | 1.01   |  |
| ٧   | 0.035 | 0.050     | 0.89        | 1.27   |  |
| Z   | 0.155 |           | 3.93        | 1 12.0 |  |

### STYLE 2:

### PIN 1. GATE

- DRAIN 2.
- SOURCE
- 4. DRAIN

### 3 IPAK, STRAIGHT LEAD CASE 369AC-01 ISSUE O



### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
   CONTROLLING DIMENSION: INCH.

- SEATING PLANE IS ON TOP OF DAMBAR POSITION.
   DIMENSION A DOES NOT INCLUDE DAMBAR POSITION OR MOLD GATE.

|     | INC       | HES   | MILLIMETERS |      |  |  |
|-----|-----------|-------|-------------|------|--|--|
| DIM | MIN       | MAX   | MIN         | MAX  |  |  |
| Α   | 0.235     | 0.245 | 5.97        | 6.22 |  |  |
| В   | 0.250     | 0.265 | 6.35        | 6.73 |  |  |
| С   | 0.086     | 0.094 | 2.19        | 2.38 |  |  |
| D   | 0.027     | 0.035 | 0.69        | 0.88 |  |  |
| E   | 0.018     | 0.023 | 0.46        | 0.58 |  |  |
| F   | 0.037     | 0.043 | 0.94        | 1.09 |  |  |
| G   | 0.090 BSC |       | 2.29 BSC    |      |  |  |
| Н   | 0.034     | 0.040 | 0.87        | 1.01 |  |  |
| J   | 0.018     | 0.023 | 0.46        | 0.58 |  |  |
| K   | 0.134     | 0.142 | 3.40        | 3.60 |  |  |
| R   | 0.180     | 0.215 | 4.57        | 5.46 |  |  |
| ٧   | 0.035     | 0.050 | 0.89        | 1.27 |  |  |
| w   | 0.000     | 0.010 | 0.000       | 0.25 |  |  |

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